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Study of the Sintering Process Behavior on Some Structural and Physical Properties of (Ni-47Ti-3Cu) Alloy Prepared by Powder Metallurgy

Mustafa Khaled Nasef¹, Rasha Hamid Ahmed¹

^{1,2}Tikrit University, Collage of Education for Pure Sciences ,Physics Department E-mail: mi230044pep@st.tu.edu.iq

KEYWORDS

Alloys, Powder Metallurgy, Heat Treatment, Sintering, Physical Properties

ABSTRACT

This research aims to prepare the alloy (Ni-47Ti-3Cu) using powder metallurgy techniques and study the sintering behavior of this alloy at different temperatures. Powders of nickel, titanium, and copper, were mixed to ensure homogeneity, then compacted under a pressure of (5ton) for (2 min) to obtain cohesive samples. The sintering process was carried out at temperatures of (1050, 950, 850, 750, 650) °C for 1 hour. The structural properties were studied using X-ray diffraction (XRD), and the physical properties (apparent density, bulk density, porosity, and water absorption) were examined using Archimedes' principle-based tests. The XRD results indicated the emergence of a new phase with a different crystalline structure from the elements used in the preparation of the models, identified as (TiCuNi2) with a rhombohedral crystal system, while the constituent elements of the alloy exhibited face-centered cubic (F.C.C) structures for nickel and copper and a hexagonal close-packed (H.C.P) structure for titanium. The physical examination results showed that both apparent and bulk densities increased with increasing sintering temperature, while porosity and water absorption decreased with increasing sintering temperature.

1. Introduction

A mixture of elements with diverse properties can yield suitable characteristics for many engineering applications, often surpassing those of pure elements [1]. An alloy, which is a mixture formed from the complete or partial union of two or more chemical elements, typically exhibits superior properties compared to the base metal involved [2]. The (Ni-50Ti-4Cu) alloy is an attractive choice for applications requiring a combination of exceptional structural and physical properties, such as machine parts and equipment operating in harsh environments, due to its structural stability, durability, high corrosion resistance, excellent formability, and high-temperature resistance [3-5]. Nickel is known for its good mechanical properties and high corrosion resistance. It also easily combines with many metals, making it a component of many important alloys, including (Ni-Ti) [6]. Titanium exhibits properties similar to steel, with high mechanical resistance and significant corrosion resistance, but it is lighter than steel [7,8]. It is used in many alloys alongside iron, aluminum, nickel, and other elements to produce strong and lightweight alloys [9]. Copper is notable for its ease of forming, high electrical conductivity, and wide range of alloys, including brasses, bronzes, and cupronickels, where copper is added to nickel to enhance mechanical properties and reduce alloy costs [10]. There are several methods for preparing alloys, one of which is powder metallurgy. This technique is valuable for creating a variety of microstructures and producing materials with all the distinctive physical, chemical, and mechanical properties, allowing the manufacture of products from almost any metal, including alloys that cannot be produced using traditional metallurgical methods [11,12]. Sintering is one of the most crucial thermal treatments for cold-pressed products. It involves heating the product to (70-90) % of the metal's melting temperature to reduce porosity and achieve a dense and hard structure. Coldpressed products have low green strength, necessitating the enhancement of their mechanical and physical properties through the irreversible process of sintering [13,14].

2. Experimental part

The (Ni-50Ti-4Cu) alloy was prepared using powder metallurgy techniques. The first step in sample preparation involved procuring the powders of the elements used in this study: nickel (Ni) and copper with 99.95% purity from Buchs Fluka AG (Germany), and titanium powder with 99.99% purity from Sky Spring Nanomaterials (USA). These powders were weighed using a precise balance (Sartorius) of Japanese origin with an accuracy of 0.0001 according to the following ratios: (46% Ni + 50% Ti + 4% Cu). The powders were then mixed manually for half an hour using an agate mortar to achieve homogeneity. After mixing, a homogeneous powder mixture was obtained. The compaction process



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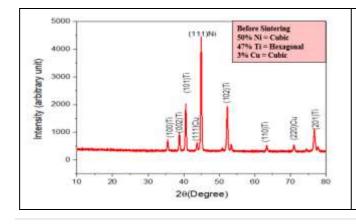
was conducted using uniaxial pressing. The mixture was placed in a high-density steel mold with excellent mechanical properties, which was then inserted into a uniaxial hydraulic press (HONMAKSAN) of Turkish origin and compressed under a pressure of (5ton) for (2 min) to avoid elastic rebound. Six samples of the alloy were produced. The sintering process followed, using a CARBOLITE electric furnace (German origin) at temperatures of °C (1050, 950, 850, 750, 650) for 1 hour. To determine the structural properties, the samples were examined using X-ray diffraction (XRD) with a PANALYTICAL'S AERIS device of American origin, and International Centre for Diffraction Data (ICDD) cards were used. The physical properties (apparent density, bulk density, apparent porosity, and water absorption) were measured using Archimedes' principle-based physical tests.

3. Results and Discussion

Structural Properties

X-ray Diffraction (XRD) Analysis

This technique was employed to understand the crystalline structure of the prepared alloy and to observe the effect of increased sintering temperature on this structure. Before sintering, XRD analysis, aided by ICDD cards, showed only the peaks of the basic materials, indicating that the main components of the alloy (Ti, Ni, Cu) were in an unreacted state and no new compounds had formed. According to Table (1), nickel appeared at angles (°44.2583, 76.9792°) with Miller indices (111), (220), according to card number (03-065-2865), and copper appeared at angles (°43.0907, °72.3016) with Miller indices (111), (220), according to card number (01-085-1326). Thus, the crystalline structure of both nickel and copper was face-centered cubic (F.C.C). Titanium appeared at angles (°35.8834, °39.1697, °40.936, °52.5847, °77.0167) with Miller indices (100), (002), (101), (102), (201), according to card number (00-001-1197), indicating a hexagonal crystal structure for titanium. After sintering, a new phase (TiCuNi2) was observed in all samples. This new ternary alloy with a rhombohedral crystal system appeared at angles (°28.9164, °54.7647, °63.2788) with Miller indices (002), (200), (114), according to card number (00-101-0026). This indicates an atomic exchange reaction among the alloying elements and the formation of new bonds, resulting in the (TiCuNi2) phase during sintering, significantly impacting the structural, physical, and mechanical properties [15]. Moreover, with increasing sintering temperature, the intensity peaks of the primary materials (which remained after sintering) decreased, as illustrated in Figures (1), (2), (3), (4), (5), and (6). This was due to the reaction during sintering, leading to the transformation of some primary materials into the (TiCuNi2) compound with a different structure and changes in crystalline properties due to the high temperatures. Additionally, the intensity peaks of the (TiCuNi2) compound increased with higher temperatures, especially in sample (5) at 950°C, then slightly decreased in sample (6) at 1050°C. The reason is that the temperature ranges from 650°C to 950°C promoted the formation and homogeneity of this compound's crystalline structure, while the slight decrease in intensity at 1050°C could be attributed to changes in the crystalline properties (irregular crystalline surfaces) and increased grain growth [16].



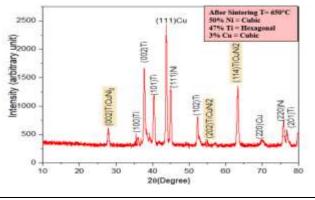




Fig. (1) X-ray diffraction of sample (1) before Fig. (2) X-ray diffraction of sample (2) at a sintering temperature of (650°C) 3500 3500 After Sintering T= 750°C 50% Ni = Cubic 47% Ti = Hesagonal 3% Cu = Cubic After Sintering T= 850°C 50% Ni = Cubic 47% Ti = Hexagonal (111)Cu 3000 3000 (arbitrary unit) Intensity (arbitrary unit) 2500 2000 Intensity 1500 1000 500 20 30 50 60 10 40 20 30 40 50 60 70 20(Degree) 28(Degree) Fig. (3) X-ray diffraction of sample (3) at a Fig. (4) X-ray diffraction of sample (4) at temperature of (750°C) a temperature of (850°C) 2500 7000 After Sintering T= 1050°C 50% Ni = Cubic 47% Ti = Hexagonal After Sintering T= 950°C 50% Ni = Cubic (111)Cu 6000 2000 intensity (arbitrary unit) 3% Cu = Cubi 5000 1000 2000 201 1000 o 20 30 50 70 40 60 10 20 30 40 50 20(Degree) 2θ(Degree) Fig. (5) X-ray diffraction of sample (5) at a Fig. (6) X-ray diffraction of sample (6) at a temperature of (950°C) temperature of (1050°C)

Table (1) X-ray diffraction results before and after sintering

Tempe ratures (°C)	2Theta (Degre e)	FWH M (Deg)	d _{hkl} Exp (°A)	C.S (nm)	hkl	Phase	System	Card No
Before Sinterin	35.8834	0.1864	2.50057	53.1667897	(100)	Ti	Hexagonal	00-001- 1197
g	39.1697	0.1863	2.29801	55.5922284 7	(002)	Ti	Hexagonal	00-001- 1197
	40.936	0.1945	2.20284	54.6467138 8	(101)	Ti	Hexagonal	00-001- 1197
	43.0907	0.1763	2.05227	62.3658845 4	(111)	Cu	Cubic	01-085- 1326
	44.2583	0.1918	2.002	58.4522602	(111)	Ni	Cubic	03-065-



				4				2865
	52.5847	0.2433	1.78239	54.3167130	(102)	Ti	Hexagonal	00-001- 1197
	72.3016	0.2591	1.73901	101.937628	(220)	Cu	Cubic	01-085- 1326
	76.9792	0.3847	1.70471	92.6386430	(220)	Ni	Cubic	03-065- 2865
	77.0167	0.2531	1.46057	141.206024 8	(201)	Ti	Hexagonal	00-001- 1197
650	28.9164	0.4219	3.19342	21.5379296 4	(002)	TiCuNi 2	rhombohedr al	00-101- 0026
	35.4111	0.2806	2.53284	35.1100284 3	(100)	Ti	Hexagonal	00-001- 1197
	38.5352	0.5735	2.33438	17.8986105 5	(002)	Ti	Hexagonal	00-001- 1197
	40.3886	0.1829	2.23142	57.6375828	(101)	Ti	Hexagonal	00-001- 1197
	43.7542	0.3375	2.06727	32.9371012 7	(111)	Cu	Tetragonal	01-085- 1326
	44.9561	0.2966	2.01475	38.255694	(111)	Ni	Cubic	03-065- 2865
	52.3238	0.2849	1.74707	46.1115948	(102)	Ti	Hexagonal	00-001- 1292
	54.7647	0.3562	1.67483	39.0718031 5	(200)	TiCuNi 2	rhombohedr al	00-101- 0026
	63.2788	0.4179	1.46844	42.7305257 6	(114)	TiCuNi 2	rhombohedr al	00-101- 0026
	70.163	1.17	1.34025	20.2235252	(220)	Cu	Cubic	01-085- 1326
	75.8052	0.4302	1.2539	76.1131178 8	(220)	Ni	Cubic	03-065- 2865
	76.7675		1.24057	90.6873364		Ti	Hexagonal	00-001- 1197
750	28.0683	0.1983	2.23226	45.4783845 5	(002)	TiCuNi 2	rhombohedr al	00-101- 0026
	35.4955	0.1703	2.06107	57.9108229	(100)	Ti	Hexagonal	00-001- 1197
	39.3382	0.2857	2.01074	36.3379454	(002)	Ti	Hexagonal	00-001- 1197
	40.3729	0.1628	1.74446	64.7386819	(101)	Ti	Hexagonal	00-001- 1197
	43.8927	0.1749	1.67057	63.7054961	(111)	Cu	Tetragonal	01-085- 1326
	44.0507	0.1727	1.46537	65.8100234	(111)	Ni	Cubic	03-065- 2865
	52.4079	0.1907	1.3493	69.0205868	(102)	Ti	Hexagonal	00-001- 1292
	54.9161	0.2187	1.25255	63.8760191 5	(200)	TiCuNi 2	rhombohedr al	00-101- 0026
	63.4265	0.2535	1.23926	70.8049671	(114)	TiCuNi	rhombohedr	00-101-



				7		2	al	0026
	69.6244	0.5021	2.23226	45.9303340 1	(220)	Cu	Cubic	01-085- 1326
	75.9017	0.3418	2.06107	96.4406090 5	(220)	Ni	Cubic	03-065- 2865
	76.8632	0.1889	2.01074	87.0241243	(201)	Ti	Hexagonal	00-001- 1197
850	28.3296	0.1013	3.26065	89.2229227	(002)	TiCuNi 2	rhombohedr al	00-101- 0026
	35.7268	0.2144	2.44506	46.7259989 9	(100)	Ti	Hexagonal	00-001- 1197
	37.8762	0.2433	2.37346	41.8098851	(002)	Ti	Hexagonal	00-001- 1197
	39.8107	0.2078	2.26247	50.3020019	(101)	Ti	Hexagonal	00-001- 1197
	43.9024	0.2303	2.06063	48.3886518	(111)	Cu	Tetragonal	01-085- 1326
	44.7005	0.2439	2.02568	46.3158456 6	(111)	Ni	Cubic	03-065- 2865
	52.3799	0.2698	2.00993	48.7541805 4	(102)	Ti	Hexagonal	00-001- 1292
	54.9291	0.2138	1.74533	65.3610842 6	(200)	TiCuNi 2	Rhombohed ral	00-101- 0026
	63.3507	0.3231	1.67021	55.4061460 7	(114)	TiCuNi 2	Rhombohed ral	00-101- 0026
	70.3216	0.2909	1.46694	81.9682982 9	(220)	Cu	Cubic	01-085- 1326
	75.98	0.2354	1.33762	140.797692 7	(220)	Ni	Cubic	03-065- 2865
	76.7919	0.3053	1.24023	115.104840	(201)	Ti	Hexagonal	00-001- 1197
950	28.5275	0.1561	3.12639	58.5459125	(002)	TiCuNi 2	rhombohedr al	00-101- 0026
	35.6361	0.2485	2.4509	40.2665931 8	(100)	Ti	Hexagonal	00-001- 1197
	44.621	0.1626	2.0291	69.3785711 8	(111)	Ni	Cubic	03-065- 2865
	54.8489	0.1693	1.67246	82.3768879 8	(200)	TiCuNi 2	rhombohedr al	00-101- 0026
	57.1949	0.1495	1.60931	99.1329788	(202)	TiCuNi 2	rhombohedr al	00-101- 0026
	63.1681	0.498	1.47074	35.7205759 6	(114)	TiCuNi 2	rhombohedr al	00-101- 0026
	70.2464	0.1897	1.33887	125.236736 4	(220)	Cu	Cubic	01-085- 1326
1050	28.3353	0.1699	3.14716	53.6929609 5	(002)	TiCuNi 2	rhombohedr al	00-101- 0026
	35.9389	0.2227	2.43151	44.5318540 9	(100)	Ti	Hexagonal	00-001- 1197
	40.0413	0.1592	2.24997	65.8795443	(101)	Ti	Hexagonal	00-001-



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1197				7			
03-065- 2865	Cubic	Ni	(111)	72.1975195	2.01726	0.157	44.8972
00-101- 0026	rhombohedr al	TiCuNi 2	(200)	98.5722184 5	1.66443	0.1425	54.136
00-101- 0026	rhombohedr al	TiCuNi 2	(202)	117.616777 7	1.60264	0.1269	57.4548
00-101- 0026	rhombohedr al	TiCuNi 2	(114)	34.7975940 2	1.46458	0.5165	63.4646
01-085- 1326	Cubic	Cu	(220)	192.237987	1.33394	0.1254	70.5442

Secondly: Physical Properties

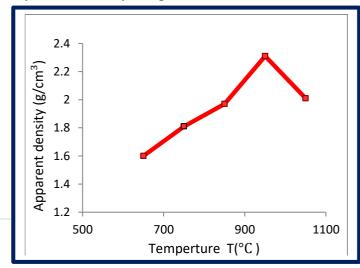
The results for apparent density, bulk density, apparent porosity, and water absorption of the alloy samples were obtained through physical tests based on Archimedes' principle.

Apparent Density

Figure (7) illustrates the relationship between the apparent density ratios as a function of varying sintering temperatures °C (650, 750, 850, 950, 1050) for the alloy samples. Table (2) presents the apparent density ratios for these samples, where the following observations were made The apparent density of the alloy samples increased after sintering compared to before sintering. This increase is due to the thermal expansion of the grains, which leads to the reduction of porosity, thereby increasing the apparent density [17, 18, 19]. The apparent density increases with rising sintering temperature. This can be attributed to the fact that higher temperatures enhance the bonding strength between the particles of the sample's constituent elements, thereby reducing porosity and increasing apparent density [20]. The crystal structure and grain size change to a more interconnected and dense structure, as indicated by the formation of the (TiCuNi2) compound according to XRD results [21]. The apparent density begins to decrease at the sintering temperature of 1050°C, being lower than at 950°C. This can be explained by the fact that sintering at such a high temperature leads to changes in the shape and distribution of the pores, increasing their diameter. Most of the smaller pore's merge into larger ones, which negatively affects the overall density, including the apparent density [22].

Table (2) Apparent Density ratios of alloy samples

Temperature (C°)	Apparent Density (g/cm³)
Before Sintering	1.31
650	1.60
750	1.81
850	1.97
950	2.31
1050	2.01





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Fig. (7) The relationship between Apparent Density ratios as a function of changing sintering

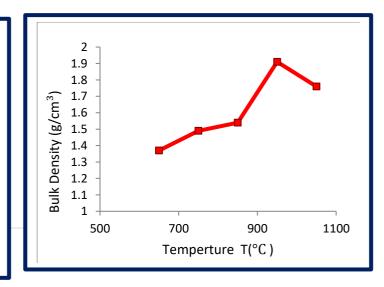
Bulk Density

Figure (8) shows the relationship between bulk density ratios as a function of varying sintering temperatures (650, 750, 850, 950, 1050) °C for the alloy samples. Table (3) presents the bulk density ratios for these samples, determined based on Archimedes' principle, both before and after sintering. The following observations were made: The bulk density of the alloy samples increased after sintering compared to before sintering. This increase is due to solid-state diffusion, which leads to an increase in bulk density [23]. The bulk density increases with rising sintering temperature. This can be attributed to the fact that higher temperatures lead (in addition to solid-state diffusion) to the fusion of the particles of the constituent elements of the sample. The similar densities of nickel and copper (8.90 g/cm³ for nickel and 8.95 g/cm³ for copper) facilitate this fusion [23]. This fusion results in a rearrangement of atoms or molecules in the crystal lattice, changing the crystal structure and forming new phases, as indicated by XRD analysis (formation of the TiCuNi2 phase). Occasionally, lattice compression may also occur. All these factors undoubtedly lead to an increase in bulk density [24].

The bulk density begins to decrease at the sintering temperature of 1050°C, being lower than at 950°C. This can be explained by the fact that sintering at such a high temperature leads to increased diffusion of nickel and copper into titanium. Elements with lower melting points (nickel and copper) will diffuse into the element with a higher melting point (titanium in this case). As a result, regions in the sample that are rich in nickel and copper will experience material loss due to the migration of atoms, leading to an imbalance in void distribution across the regions. These regions will eventually reach supersaturation, resulting in the formation of pores due to the accumulation of voids, and consequently, a slight decrease in bulk density [25].

Table (3) Bulk Density ratios of alloy

Temperature (C°)	Bulk Density (g/cm³)
Before Sintering	1.23
650	1.37
750	1.49
850	1.54
950	1.91
1050	1.76





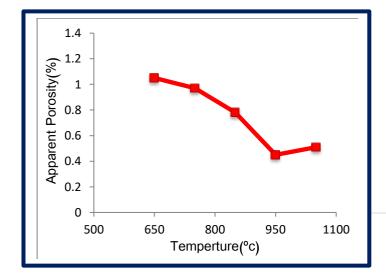
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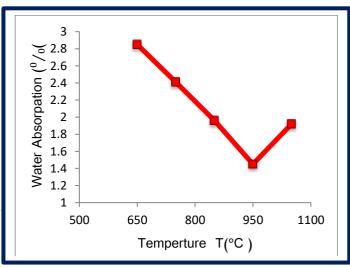
Fig. (8) The relationship between Bulk Density ratios as a function of changing sintering

Porosity and Water Absorption

Figure (9) illustrates the relationship between apparent porosity ratios as a function of varying sinterng temperatures (650, 750, 850, 950, 1050°C). Figure (10) shows the relationship between water absorption ratios as a function of the same sintering temperature range. Table (4) presents the apparent porosity ratios for the alloy samples, while Table (5) presents the water absorption ratios for these samples. The following observations were made: Upon sintering the samples, both apparent porosity and water absorption decreased compared to their values before sintering. This decrease is attributed to the role of heat in enhancing the bonding between the particles of the sample elements, which reduces overall porosity, particularly apparent porosity. Since absorption depends on porosity where water absorption requires the presence of voids (open pores) between the material particles reducing apparent porosity will also reduce water absorption [26]. With an increase in sintering temperature, apparent porosity and water absorption continue to decrease. This is because higher sintering temperatures lead to stronger bonds between the particles of the sample elements as atoms and molecules occupy more optimal positions due to the heat, promoting grain growth. Consequently, the shape and size of the pores change and diminish consistently [24]. Additionally, the formation of more compact phases, such as the TiCuNi2 phase identified by XRD analysis, contributes to the elimination of many pores, thereby reducing water absorption as well [27].

At a sintering temperature of 1050°C, both apparent porosity and water absorption start to rise slightly, becoming marginally higher than at 950°C. This can be explained by the increased diffusion of nickel and copper into titanium at this high temperature. Regions in the sample that are rich in nickel and copper will experience material loss as they lose more atoms, disrupting the balance of voids in one area compared to another. The aggregation of these voids leads to pore formation, resulting in a slight increase in apparent porosity and consequently, water absorption as well at the temperature of 1050°C [25].





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Figure (9) Relationship between apparent porosity as a function of changing sintering temperature

Fig. (10): The relationship between water absorbency as a function of changing sintering, temperature

Table (5) Water absorption percentage of alloy

Table (4) Apparent porosity ratios of alloy samples

Temperature (°C)	Apparent porosity (%)
Before Sintering	1.01
650	1.05
750	0.97
850	0.78
950	0.45
1050	0.51
	·

Temperature (°C)	Water Absorption (%)
Before Sintering	3.04
650	2.85
750	2.41
850	1.96
950	1.45
1050	1.92

4. Conclusions:

After conducting tests on the study samples, the following conclusions were reached: The preparation method used (powder metallurgy technique) was successful. It is possible to obtain a new phase different from the phases of the original alloy components. The phase (TiCuNi2) with a rhombohedral crystal system was obtained, while the crystal systems of the elements forming the alloy are facecentered cubic (F.C.C) and hexagonal. A sintering time of one hour helped improve the properties of the studied alloy depending on the temperatures. The best apparent and bulk density values for the alloy were at a temperature of 950°C, where they reached their highest value. The best porosity and water absorption rates for the alloy were at a temperature of 950°C, where they reached their lowest value. From all the above, it is clear that the best sintering temperature for the studied alloy is 950°C for one hour.

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